

MM54HC02/MM74HC02 Quad 2-Input NOR Gate

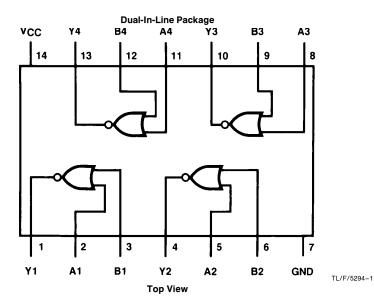
General Description

These NOR gates utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits. All gates have buffered outputs, providing high noise immunity and the ability to drive 10 LS-TTL loads. The 54 HC/74 HC logic family is functionally as well as pinout compatible with the standard 54 LS/74 LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

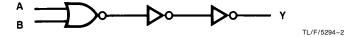
Features

- Typical propagation delay: 8 ns
- Wide power supply range: 2-6V
- Low quiescent supply current: 20 μ A maximum (74HC Series)
- Low input current: 1 μ A maximum
- High output current: 4 mA minimum

Connection and Logic Diagrams



Order Number MM54HC02 or MM74HC02



Absolute Maximum Ratings (Notes 1 & 2) If Military/Aerospace specified devices are required,

please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

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Supply Voltage (V _{CC})	-0.5 to $+7.0$ V
DC Input Voltage (V _{IN})	-1.5 to $V_{\rm CC}$ $+$ $1.5V$
DC Output Voltage (V _{OUT})	-0.5 to $V_{\text{CC}} + 0.5 \text{V}$
Clamp Diode Current (I _{IK} , I _{OK})	\pm 20 mA
DC Output Current, per pin (IOUT)	\pm 25 mA
DC V _{CC} or GND Current, per pin (I _{CC})	\pm 50 mA
Storage Temperature Range (T _{STG})	-65°C to +150°C

Power Dissipation (PD) (Note 3)

600 mW S.O. Package only 500 mW Lead Temp. (T_L) (Soldering 10 seconds) 260°C

Operating Conditions

Min	Max	Units
2	6	V
0	V _{CC}	V
-40	+85	°C
-55	+125	°C
	1000	ns
	500	ns
	400	ns
	2 0 -40	2 6 0 V _{CC} -40 +85 -55 +125

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		74HC T _A = -40 to 85°C	54HC T _A = -55 to 125°C	Units
				Тур		Guaranteed		
V _{IH}	Minimum High Level Input Voltage		2.0V 4.5V 6.0V		1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V V V
V _{IL}	Maximum Low Level Input Voltage**		2.0V 4.5V 6.0V		0.5 1.35 1.8	0.5 1.35 1.8	0.5 1.35 1.8	V V V
V _{OH}	Minimum High Level Output Voltage	V _{IN} =V _{IL} I _{OUT} ≤20 μA	2.0V 4.5V 6.0V	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V V V
		$V_{IN} = V_{IL}$ $ I_{OUT} \le 4.0 \text{ mA}$ $ I_{OUT} \le 5.2 \text{ mA}$	4.5V 6.0V	4.2 5.7	3.98 5.48	3.84 5.34	3.7 5.2	V
V _{OL}	Maximum Low Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 20 \mu A$	2.0V 4.5V 6.0V	0 0 0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V V V
		$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 4.0 \text{ mA}$ $ I_{OUT} \le 5.2 \text{ mA}$	4.5V 6.0V	0.2 0.2	0.26 0.26	0.33 0.33	0.4 0.4	V V
I _{IN}	Maximum Input Current	V _{IN} =V _{CC} or GND	6.0V		±0.1	±1.0	±1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$	6.0V		2.0	20	40	μΑ

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC}=5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

^{**}V_{IL} limits are currently tested at 20% of V_{CC}. The above V_{IL} specification (30% of V_{CC}) will be implemented no later than Q1, CY'89.

AC Electrical Characteristics $v_{CC}\!=\!5\text{V},\,T_{A}\!=\!25^{\circ}\text{C},\,C_{L}\!=\!15\,\text{pF},\,t_{r}\!=\!t_{f}\!=\!6\,\text{ns}$

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation Delay		8	15	ns

$\textbf{AC Electrical Characteristics} \ \ V_{CC} = 2.0 \ V \ \text{to 6.0V, C}_L = 50 \ \text{pF, t}_r = t_f = 6 \ \text{ns (unless otherwise specified)}$

Symbol	Parameter	Conditions V	v _{cc}	T _A = 25°C		74HC T _A = -40 to 85°C	54HC T _A = -55 to 125°C	Units
				Тур	Guaranteed Limits			
t _{PHL} , t _{PLH}	Maximum Propagation Delay		2.0V 4.5V 6.0V	45 9 8	90 18 15	113 23 19	134 27 23	ns ns ns
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time		2.0V 4.5V 6.0V	30 8 7	75 15 13	95 19 16	110 22 19	ns ns ns
C _{PD}	Power Dissipation Capacitance (Note 5)	(per gate)		20				pF
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF

 $\textbf{Note 5:} \ \ C_{PD} \ \ \text{determines the no load dynamic power consumption, } \ P_D = C_{PD} \ \ V_{CC}^2 \ f + I_{CC} \ \ V_{CC}, \ \ \text{and the no load dynamic current consumption, } \ I_S = C_{PD} \ \ V_{CC} \ f + I_{CC}.$

Physical Dimensions inches (millimeters) 0.785 (19.939) MAX [14] [13] [12] [11] [10] [9] [8] 0.025 (0.635) RAD 0.220-0.310 (5.588-7.874) 1 2 3 4 5 6 7 0.290-0.320 0.005 0.200 (D.127) MIN GLASS SEALANT (5.080) MAX 0.020-0.060 (7.366-8.128) 0.060 ±0.005 (1.524 ±0.127) 0.180 (0.508 - 1.524)MA 0.008-0.012 10° MAX (0.203-0.305) 0.310-0.410 D.018 ±0.003 0.125-0.200 0.098 (7.874 - 10.41)(0.457 ±0,076) (3.175-5.080) (2.489) MAX BOTH ENDS 0.100 ±0.010 0.150 (3.81) J14A (REV G) MIN Order Number MM54HC02J or MM74HC02J NS Package J14A 14 13 12 11 10 9 AREA 1 2 3 4 5 6 7 0.092 DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ (1.651) 0.125 - 0.150 (3.175 - 3.810) 0.075 ±0.015 (1.905 ±0.381) 0.280 (7.112)-MIN 0.014-0.023 (0.356-0.584) TYP 0.050 ± 0.010 (1.270 - 0.254) TYP $\begin{array}{r} 0.325 -0.015 \\ \hline (8.255 +1.016) \\ -0.381 \end{array}$ Order Number MM74HC02N

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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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